

- Sub B/
- Rule 1.26
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- 11 (Added) The method of claim 14, wherein providing the optical wave-guide comprises etching or molding a silicon-based material to produce the wave-guide.
- 18 (Added) The method of claim 14, wherein the substrate comprises at least two layers of materials.
- 19 (Added) The method of claim 18, wherein the at least two materials comprises silica wafers, dielectric materials, adhesive materials, resins, metals, metal alloys, and composite materials.
- 20 (Added) The method of claim 14, wherein the wave-guide is a silicon-based material.

**IN THE SPECIFICATION**

Insert the following before "Field of the Invention":

This application is a divisional of pending application Serial Number 09/752,408, filed December 28, 2000.

**REMARKS**

No new matter was added by this preliminary amendment.

Please use H0001800 DIV (4960) as the docket number for this application.